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Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	I²C, SPI
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	15
Program Memory Size	3.5KB (2K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 5.5V
Data Converters	A/D 6x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	20-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lc770-i-ss

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TABLE 2-1: PIC16C717/770/771 SPECIAL FUNCTION REGISTER SUMMARY (CONTINUED)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Details on Page:
Bank 1											
80h(3)	INDF	Addressing this location uses contents of FSR to address data memory (not a physical register)								0000 0000	23
81h	OPTION_REG	$\overline{RBPU}$	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	15
82h(3)	PCL	Program Counter's (PC) Least Significant Byte								0000 0000	22
83h(3)	STATUS	IRP	RP1	RP0	$\overline{TO}$	$\overline{PD}$	Z	DC	C	0001 1xxx	14
84h(3)	FSR	Indirect data memory address pointer								xxxx xxxx	23
85h	TRISA	PORTA Data Direction Register								1111 1111	25
86h	TRISB	PORTB Data Direction Register								1111 1111	33
87h	—	Unimplemented								—	—
88h	—	Unimplemented								—	—
89h	—	Unimplemented								—	—
8Ah(1,3)	PCLATH	—	—	—	Write Buffer for the upper 5 bits of the Program Counter					---0 0000	22
8Bh(3)	INTCON	GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	16
8Ch	PIE1	—	ADIE	—	—	SSPIE	CCP1IE	TMR2IE	TMR1IE	-0-- 0000	17
8Dh	PIE2	LVDIE	—	—	—	BCLIE	—	—	—	0--- 0---	19
8Eh	PCON	—	—	—	—	OSCF	—	$\overline{POR}$	$\overline{BOR}$	---- 1-qq	21
8Fh	—	Unimplemented								—	—
90h	—	Unimplemented								—	—
91h	SSPCON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000 0000	69
92h	PR2	Timer2 Period Register								1111 1111	52
93h	SSPADD	Synchronous Serial Port (I^2C mode) Address Register								0000 0000	76
94h	SSPSTAT	SMP	CKE	D/$\overline{A}$	P	S	R/$\overline{W}$	UA	BF	0000 0000	66
95h	WPUB	PORTB Weak Pull-up Control								1111 1111	34
96h	IOCB	PORTB Interrupt on Change Control								1111 0000	34
97h	P1DEL	PWM 1 Delay value								0000 0000	62
98h	—	Unimplemented								—	—
99h	—	Unimplemented								—	—
9Ah	—	Unimplemented								—	—
9Bh	REFCON	VRHEN	VRLEN	VRHOEN	VRLOEN	—	—	—	—	0000 ----	102
9Ch	LVDCON	—	—	BGST	LVDEN	LVV3	LVV2	LVV1	LVV0	--00 0101	101
9Dh	ANSEL	—	—	Analog Channel Select						--11 1111	25
9Eh	ADRESL	A/D Low Byte Result Register								xxxx xxxx	107
9Fh	ADCON1	ADFM	VCFG2	VCFG1	VCFG0	—	—	—	—	0000 ----	107

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented read as '0'.
Shaded locations are unimplemented, read as '0'.

Note 1: The upper byte of the program counter is not directly accessible. PCLATH is a holding register for the PC<12:8> whose contents are transferred to the upper byte of the program counter.

2: Other (non Power-up) Resets include external RESET through $\overline{MCLR}$ and Watchdog Timer Reset.

3: These registers can be addressed from any bank.

2.2.2.7 PIR2 REGISTER

This register contains the SSP Bus Collision and low-voltage detect interrupt flag bits.

Note:	Interrupt flag bits get set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

REGISTER 2-7: PERIPHERAL INTERRUPT REGISTER 2 (PIR2: 0Dh)

R/W-0	U-0	U-0	U-0	R/W-0	U-0	U-0	U-0
LVDIF	—	—	—	BCLIF	—	—	—
bit 7							bit 0

bit 7 **LVDIF:** Low Voltage Detect Interrupt Flag bit
1 = The supply voltage has fallen below the specified LVD voltage (must be cleared in software)
0 = The supply voltage is greater than the specified LVD voltage

bit 6-4 **Unimplemented:** Read as '0'

bit 3 **BCLIF:** Bus Collision Interrupt Flag bit
1 = A bus collision has occurred while the SSP module configured in I^2C Master was transmitting (must be cleared in software)
0 = No bus collision occurred

bit 2-0 **Unimplemented:** Read as '0'

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
- n = Value at POR	’1’ = Bit is set	’0’ = Bit is cleared	x = Bit is unknown

The RB0 pin is multiplexed with the A/D converter analog input 4 and the external interrupt input (RB0/AN4/INT). When the pin is used as analog input, the ANSEL register must have the proper value to select the RB0 pin as Analog mode.

The RB1 pin is multiplexed with the A/D converter analog input 5 and the MSSP module slave select input (RB1/AN5/$\overline{SS}$). When the pin is used as analog input, the ANSEL register must have the proper value to select the RB1 pin as Analog mode.

Note:	Upon RESET, the ANSEL register configures the RB1 and RB0 pins as analog inputs. Both RB1 and RB0 pins will read as '1'.

FIGURE 3-7: BLOCK DIAGRAM OF RB0/AN4/INT, RB1/AN5/$\overline{SS}$ PIN

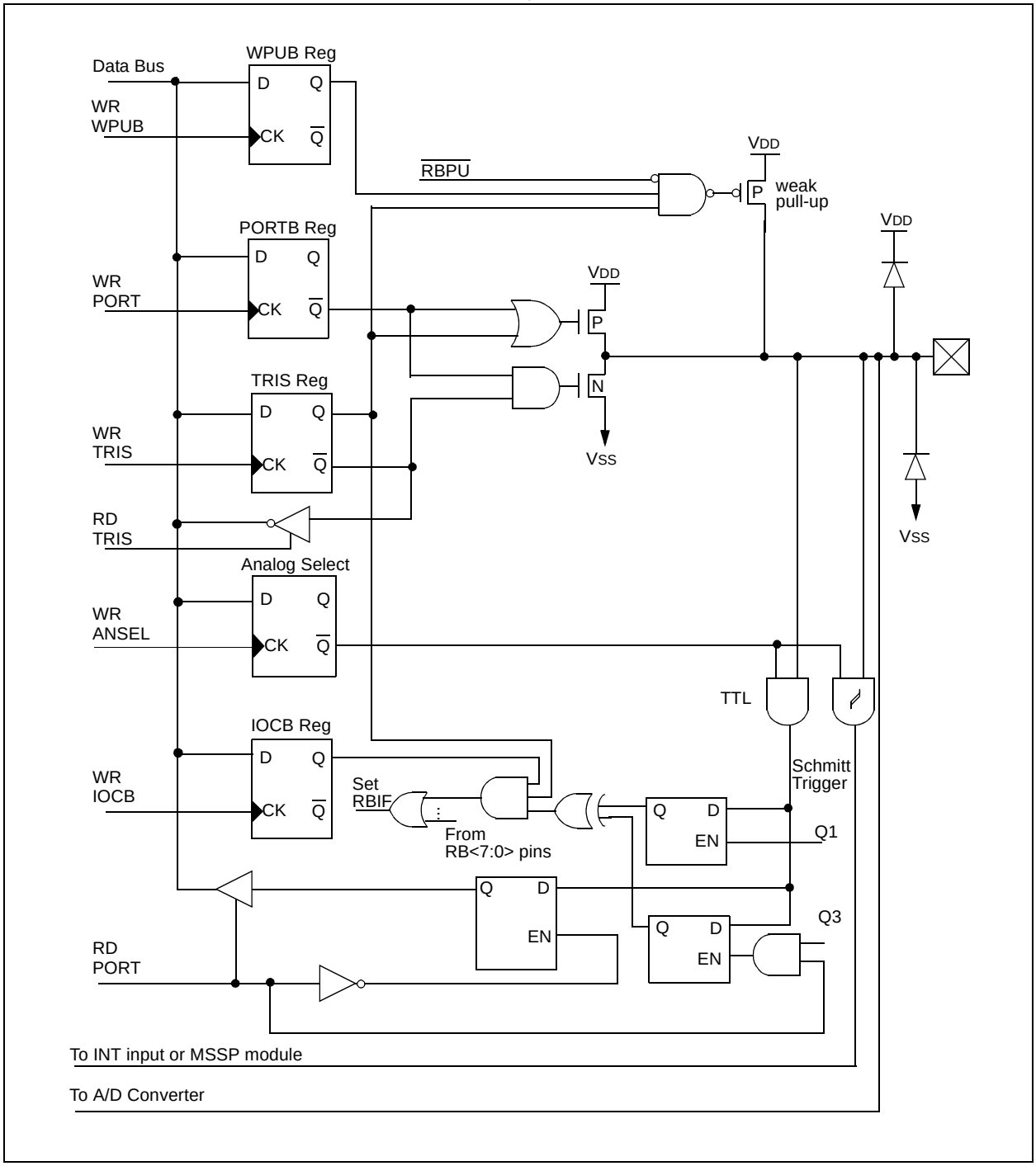
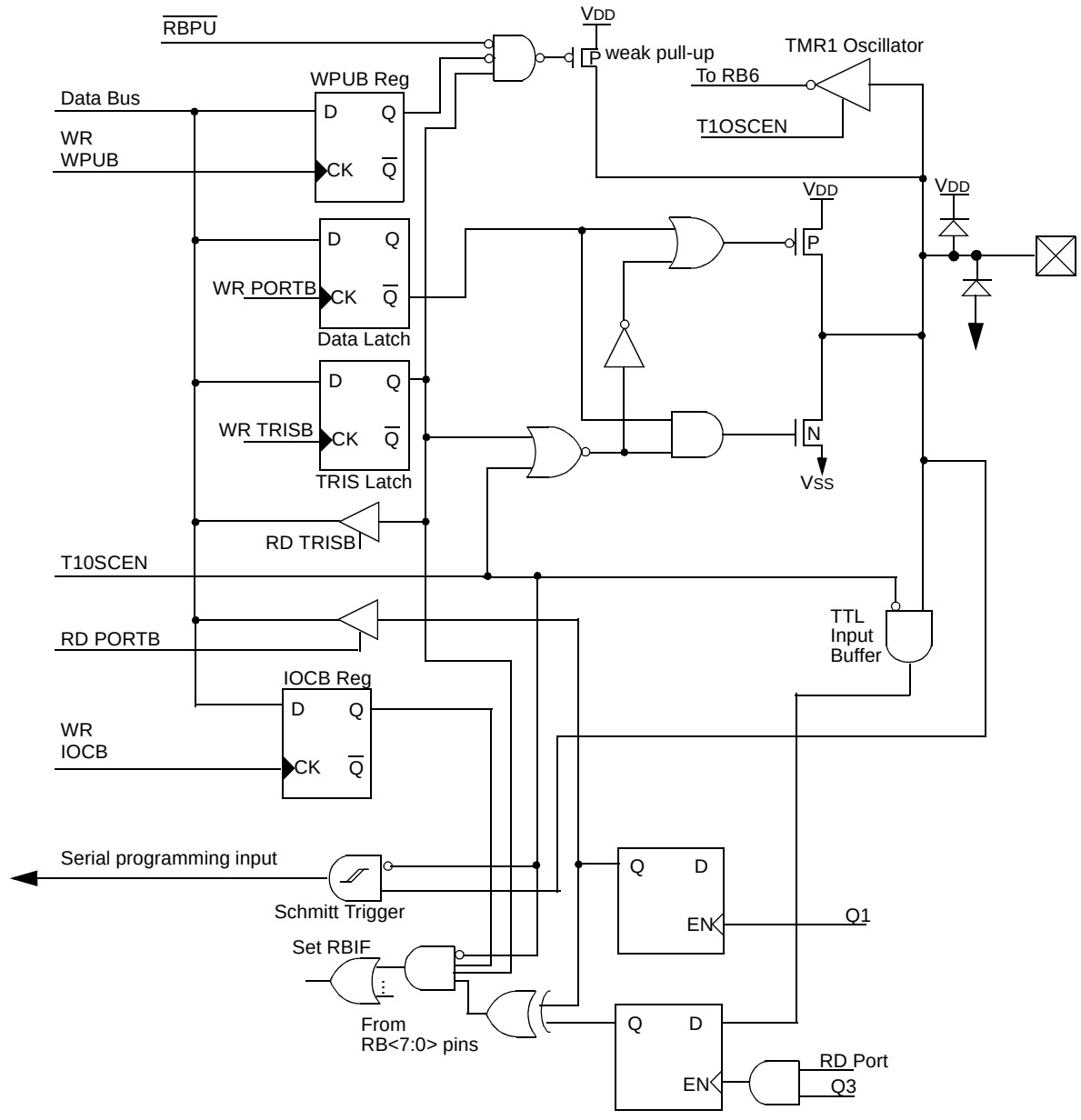


FIGURE 3-10: BLOCK DIAGRAM OF THE RB7/T1OSI/P1D



Note: The TMR1 oscillator enable (T1OSCEN = 1) overrides the RB7 I/O port and P1D functions.

4.0 PROGRAM MEMORY READ (PMR)

Program memory is readable during normal operation (full VDD range). It is indirectly addressed through the Special Function Registers:

- PMCON1
- PMDATH
- PMDATL
- PMADRH
- PMADRL

When interfacing the program memory block, the PMDATH & PMDATL registers form a 2-byte word, which holds the 14-bit data. The PMADRH & PMADRL registers form a 2-byte word, which holds the 12-bit address of the program memory location being accessed. Mid-range devices have up to 8K words of program EPROM with an address range from 0h to 3FFFh. When the device contains less memory than the full address range of the PMADRH:PMARDL registers, the Most Significant bits of the PMADRH register are ignored.

4.1 PMCON1 REGISTER

PMCON1 is the control register for program memory accesses.

Control bit RD initiates a read operation. This bit cannot be cleared, only set, in software. It is cleared in hardware at completion of the read operation.

REGISTER 4-1: PROGRAM MEMORY READ CONTROL REGISTER 1 (PMCON1: 18Ch)

R-1	U-0	U-0	U-0	U-0	U-0	U-0	R/S-0
Reserved	—	—	—	—	—	—	RD
bit 7							bit 0

bit 7 **Reserved:** Read as ‘1’

bit 6-1 **Unimplemented:** Read as '0'

bit 0 **RD**: Read Control bit

1 = Initiates a Program memory read (read takes 2 cycles). RD is cleared in hardware.
0 = Reserved

Legend:		S = Settable (cleared in hardware)	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
- n = Value at POR	’1’ = Bit is set	’0’ = Bit is cleared	x = Bit is unknown

4.2 PMDATH AND PMDATL REGISTERS

The PMDATH:PMDATL registers are loaded with the contents of program memory addressed by the PMADRH and PMADRL registers upon completion of a Program Memory Read command.

5.2.1 SWITCHING PRESCALER ASSIGNMENT

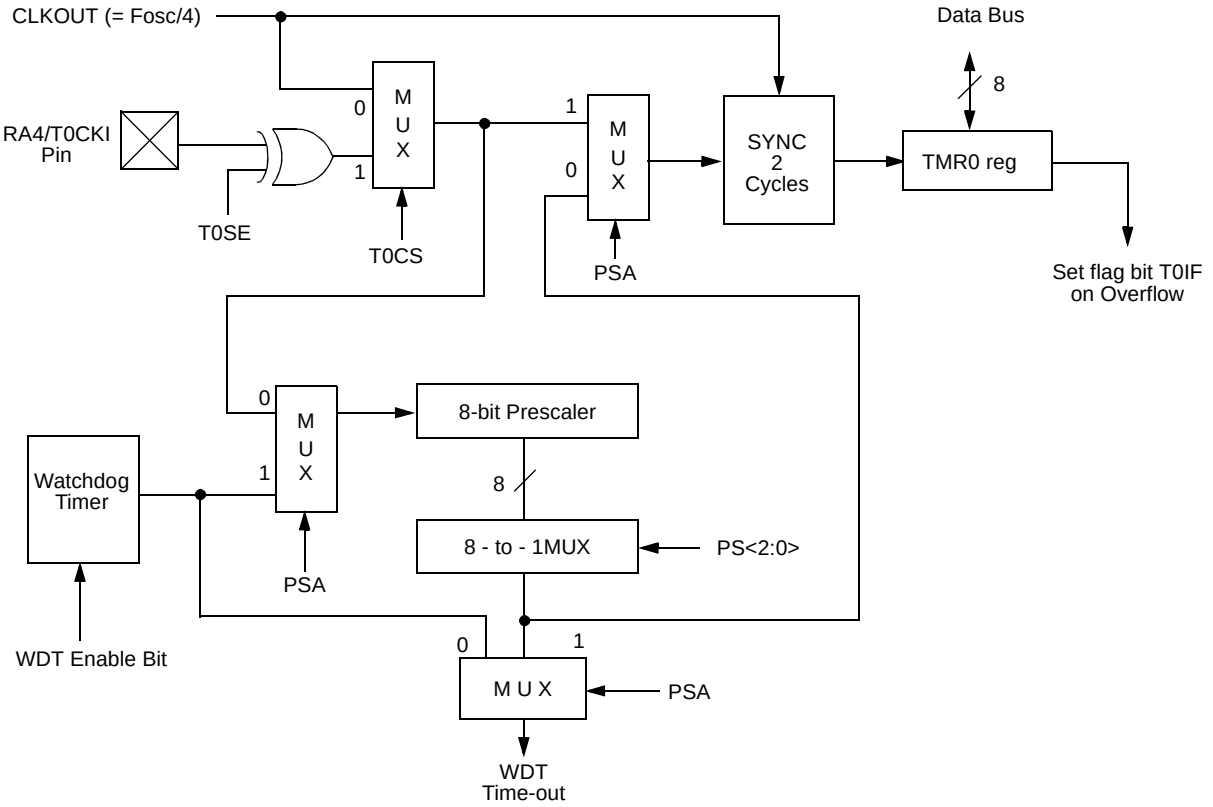
The prescaler assignment is fully under software control (i.e., it can be changed “on-the-fly” during program execution).

Note:	To avoid an unintended device RESET, a specific instruction sequence (shown in the PIC Mid-Range Reference Manual, DS33023) must be executed when changing the prescaler assignment from Timer0 to the WDT. This sequence must be followed even if the WDT is disabled.

5.3 Timer0 Interrupt

The TMR0 interrupt is generated when the TMR0 register overflows from FFh to 00h. This overflow sets bit T0IF (INTCON<2>). The interrupt can be masked by clearing bit T0IE (INTCON<5>). Bit T0IF must be cleared in software by the Timer0 module interrupt service routine before re-enabling this interrupt. The TMR0 interrupt cannot awaken the processor from SLEEP since the timer is shut off during SLEEP.

FIGURE 5-2: BLOCK DIAGRAM OF THE TIMER0/WDT PRESCALER



Note: T0CS, T0SE, PSA, PS<2:0> are (OPTION_REG<5:0>).

TABLE 5-1: REGISTERS ASSOCIATED WITH TIMER0

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
01h,101h	TMR0	Timer0 register								xxxx xxxx	uuuu uuuu
0Bh,8Bh, 10Bh,18Bh	INTCON	GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	0000 000u
81h,181h	OPTION_REG	$\overline{\text{RBPU}}$	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
85h	TRISA	PORTA Data Direction Register								1111 1111	1111 1111

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by Timer0.

8.3.2 PWM DUTY CYCLE

The PWM duty cycle is specified by writing to the CCPR1L register and to the CCP1CON<5:4> bits. Up to 10-bit resolution is available. The CCPR1L contains the eight MSbs and the CCP1CON<5:4> contains the two LSbs. This 10-bit value is represented by CCPR1L:CCP1CON<5:4>. The following equation is used to calculate the PWM duty cycle in time:

PWM duty cycle = (CCPR1L:CCP1CON<5:4>) • TOSC • (TMR2 prescale value)

CCPR1L and CCP1CON<5:4> can be written to at any time, but the duty cycle value is not latched into CCPR1H until after a match between PR2 and TMR2 occurs (i.e., the period is complete). In PWM mode, CCPR1H is a read-only register.

The CCPR1H register and a 2-bit internal latch are used to double buffer the PWM duty cycle. This double buffering is essential for glitchless PWM operation.

When the CCPR1H and 2-bit latch match TMR2 concatenated with an internal 2-bit Q clock or 2 bits of the TMR2 prescaler, the CCP1 pin is cleared.

Maximum PWM resolution (bits) for a given PWM frequency:

$$= \frac{\log\left(\frac{FOSC}{FPWM}\right)}{\log(2)} \text{bits}$$

Note:	If the PWM duty cycle value is longer than the PWM period, the CCP1 pin will not be cleared.

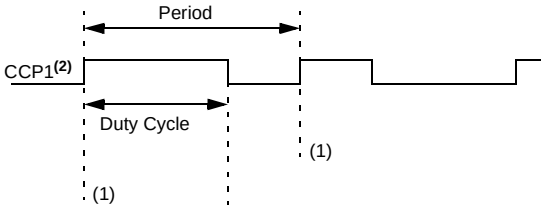
8.3.3 PWM OUTPUT CONFIGURATIONS

The PWM1M1 bits in the CCP1CON register allows one of the following configurations:

- Single output
- Half-Bridge output
- Full-Bridge output, Forward mode
- Full-Bridge output, Reverse mode

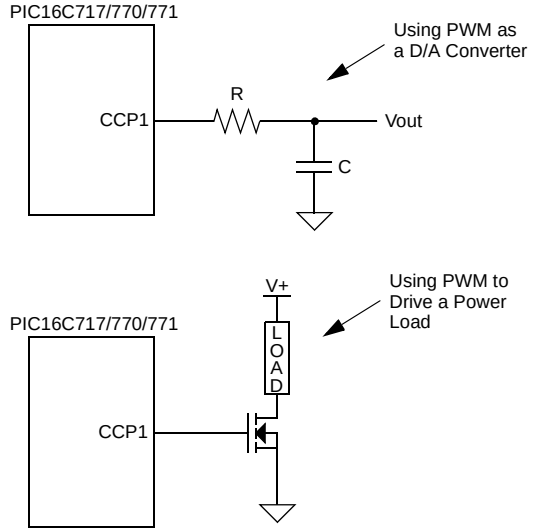
In the Single Output mode, the RB3/CCP1/P1A pin is used as the PWM output. Since the CCP1 output is multiplexed with the PORTB<3> data latch, the TRISB<3> bit must be cleared to make the CCP1 pin an output.

FIGURE 8-4: SINGLE PWM OUTPUT



Note 1: At this time, the TMR2 register is equal to the PR2 register.
2: Output signal is shown as asserted high.

FIGURE 8-5: EXAMPLE OF SINGLE OUTPUT APPLICATION



In the Half-Bridge Output mode, two pins are used as outputs. The RB3/CCP1/P1A pin has the PWM output signal, while the RB5/SDO/P1B pin has the complementary PWM output signal. This mode can be used for half-bridge applications, as shown on Figure 8-7, or for full-bridge applications, where four power switches are being modulated with two PWM signal.

Since the P1A and P1B outputs are multiplexed with the PORTB<3> and PORTB<5> data latches, the TRISB<3> and TRISB<5> bits must be cleared to configure P1A and P1B as outputs.

In Half-Bridge Output mode, the programmable deadband delay can be used to prevent shoot-through current in bridge power devices. See Section 8.3.5 for more details of the deadband delay operations.

FIGURE 9-9: I²C SLAVE MODE FOR RECEPTION (10-BIT ADDRESS)

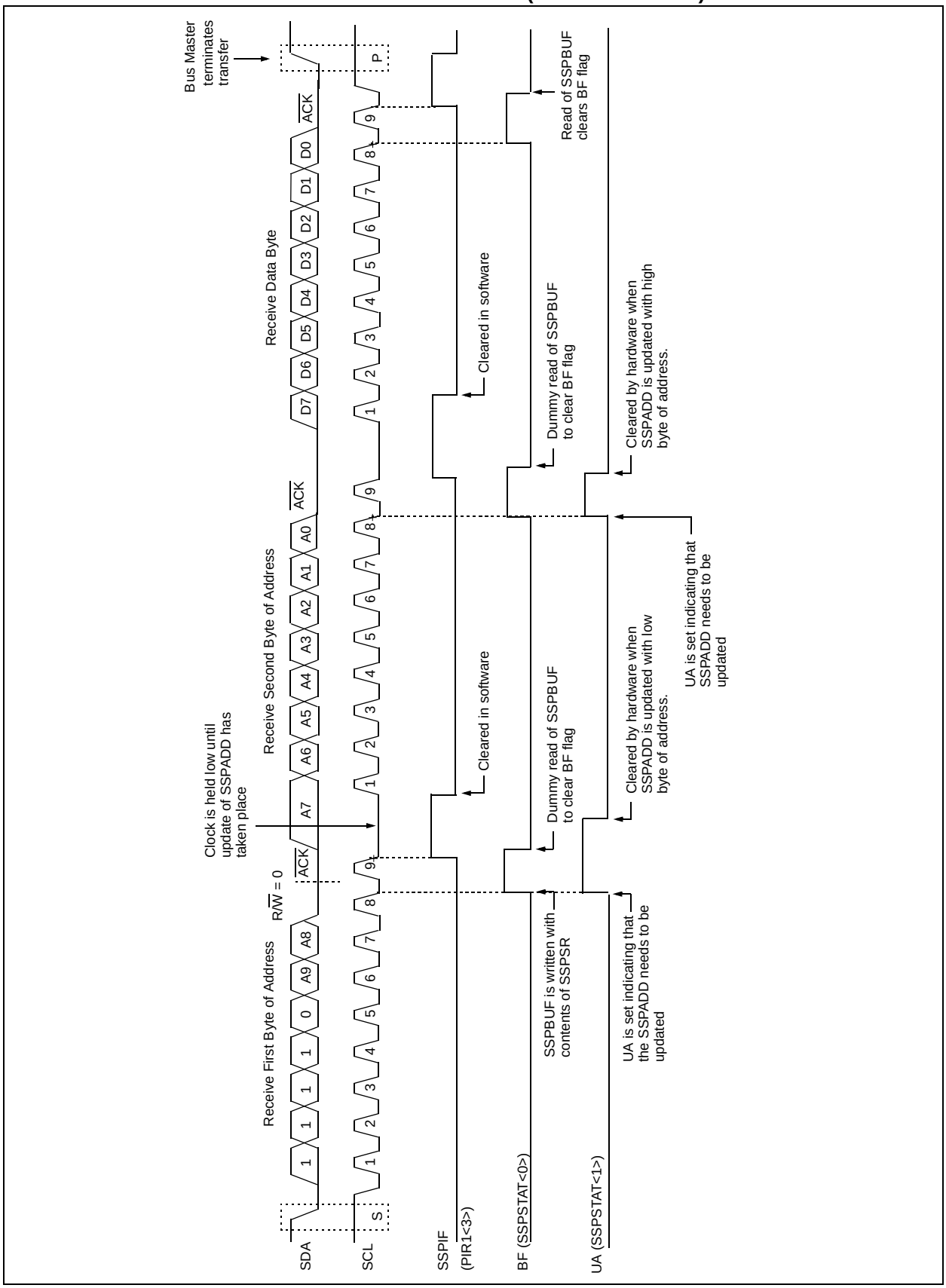
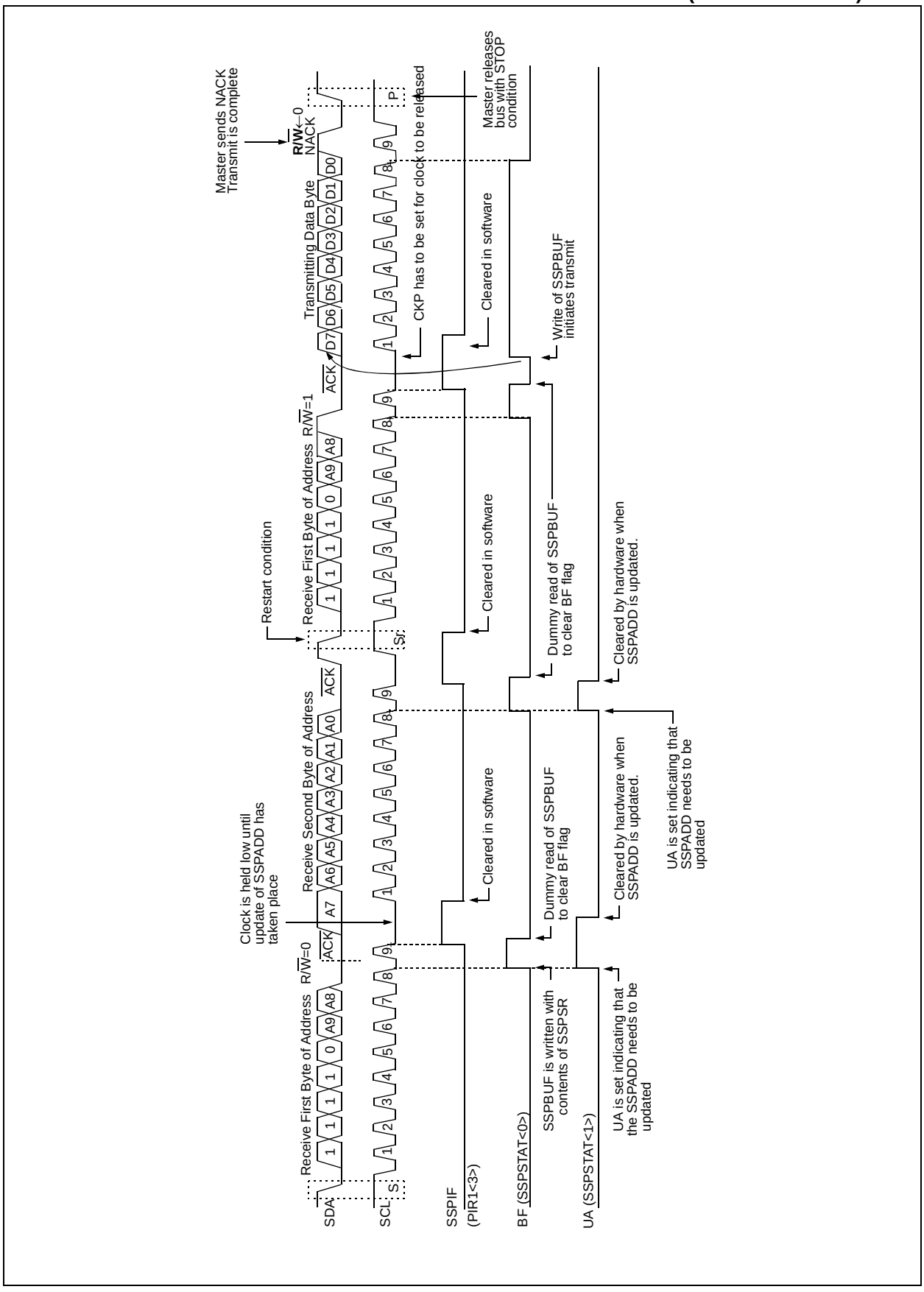


FIGURE 9-11: I²C SLAVE MODE WAVEFORMS FOR TRANSMISSION (10-BIT ADDRESS)



9.2.4 SLEEP OPERATION

While in SLEEP mode, the I^2C slave module can receive addresses or data. When an address match or complete byte transfer occurs, it wakes the processor from SLEEP (if the SSP interrupt bit is enabled).

9.2.5 EFFECTS OF A RESET

A RESET disables the MSSP module and terminates the current transfer.

9.2.6 MASTER MODE

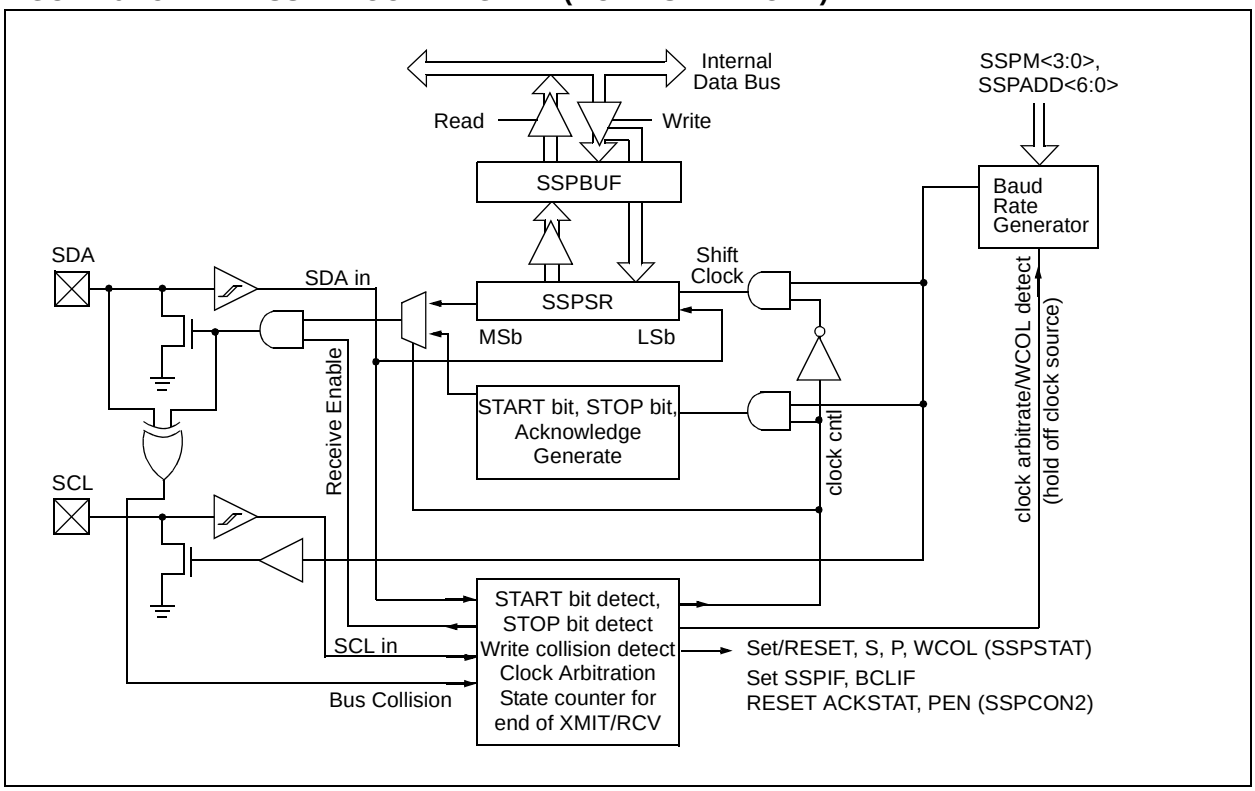
Master mode operation supports interrupt generation on the detection of the START and STOP conditions. The STOP (P) and START (S) bits are cleared from a RESET or when the MSSP module is disabled. Control of the I^2C bus may be taken when the P bit is set or the bus is idle with both the S and P bits clear.

In Master mode, the SCL and SDA lines are manipulated by the MSSP hardware.

The following events will cause SSP Interrupt Flag bit (SSPIF) to be set (SSP Interrupt, if enabled):

- START condition
- STOP condition
- Data transfer byte transmitted/received
- Acknowledge transmit
- Repeated START

FIGURE 9-13: MSSP BLOCK DIAGRAM (I^2C MASTER MODE)



EXAMPLE 11-3: CALCULATING THE MINIMUM REQUIRED SAMPLE TIME

TACQ = Amplifier Settling Time
+ Holding Capacitor Charging Time
+Temperature offset †

TACQ = 5 µs
+ TC
+ [(Temp - 25°C)(0.05 µs/°C)] †

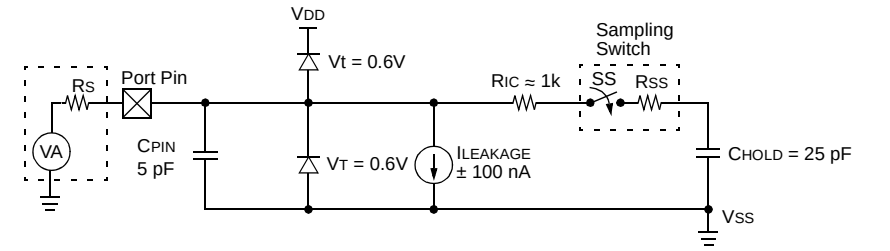
TC = Holding Capacitor Charging Time
TC = (CHOLD) (RIC + RSS + RS) In (1/16384)
TC = -25 pF (1 kΩ +10 kΩ + 2.5 kΩ) In (1/16384)
TC = -25 pF (13.5 kΩ) In (1/16384)
TC = -0.338 (-9.704)µs
TC = 3.3 µs

TACQ = 5 µs
+ 3.3 µs
+ [(50°C - 25°C)(0.05 µs / °C)]

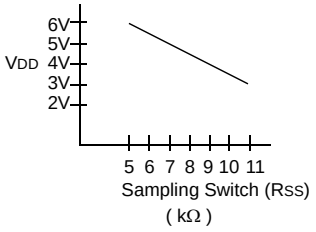
TACQ = 8.3 µs + 1.25 µs
TACQ = 9.55 µs

† The temperature coefficient is only required for temperatures > 25°C.

FIGURE 11-5: ANALOG INPUT MODEL



Legend CPIN = input capacitance
VT = threshold voltage
ILEAKAGE = leakage current at the pin due to various junctions
RIC = interconnect resistance
SS = sampling switch
CHOLD = sample/hold capacitance



15.3 AC Characteristics: PIC16C717/770/771 & PIC16LC717/770/771 (Commercial, Industrial, Extended)

15.3.1 TIMING PARAMETER SYMBOLOGY

The timing parameter symbols have been created using one of the following formats:

1. TppS2ppS
2. TppS
3. TCC:ST (I^2C specifications only)
4. Ts (I^2C specifications only)

T			
F	Frequency	T	Time

Lowercase letters (pp) and their meanings:

pp			
cc	CCP1	osc	OSC1
ck	CLKOUT	rd	$\overline{RD}$
cs	$\overline{CS}$	rw	$\overline{RD}$ or $\overline{WR}$
di	SDI	sc	SCK
do	SDO	ss	$\overline{SS}$
dt	Data in	t0	T0CKI
io	I/O port	t1	T1CKI
mc	$\overline{MCLR}$	wr	$\overline{WR}$

Uppercase letters and their meanings:

S			
F	Fall	P	Period
H	High	R	Rise
I	Invalid (Hi-impedance)	V	Valid
L	Low	Z	Hi-impedance
I^2C (I^2C specifications only)			
AA	output access		
BUF	Bus free		
High	High		
Low	Low		

TCC:ST (I^2C specifications only)

CC			
HD	Hold	SU	Setup
ST			
DAT	DATA input hold	STO	STOP condition
STA	START condition		

TABLE 15-6: ENHANCED CAPTURE/COMPARE/PWM REQUIREMENTS (ECCP)

Param. No.	Sym	Characteristic			Min	Typ†	Max	Units	Conditions
50*	TccL	CCP1 input low time	No Prescaler		0.5TCY + 20	—	—	ns	
			With Prescaler	PIC16**C**717/770/771	10	—	—	ns	
				PIC16**LC**717/770/771	20	—	—	ns	
51*	TccH	CCP1 input high time	No Prescaler		0.5TCY + 20	—	—	ns	
			With Prescaler	PIC16**C**717/770/771	10	—	—	ns	
				PIC16**LC**717/770/771	20	—	—	ns	
52*	TccP	CCP1 input period			$\frac{3T_{CY} + 40}{N}$	—	—	ns	N = prescale value (1, 4 or 16)
53*	TccR	CCP1 output fall time		PIC16**C**717/770/771	—	10	25	ns	
				PIC16**LC**717/770/771	—	25	45	ns	
54*	TccF	CCP1 output fall time		PIC16**C**717/770/771	—	10	25	ns	
				PIC16**LC**717/770/771	—	25	45	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

15.4 Analog Peripherals Characteristics: PIC16C717/770/771 & PIC16LC717/770/771 (Commercial, Industrial, Extended)

15.4.1 BANDGAP MODULE

FIGURE 15-12: BANDGAP START-UP TIME

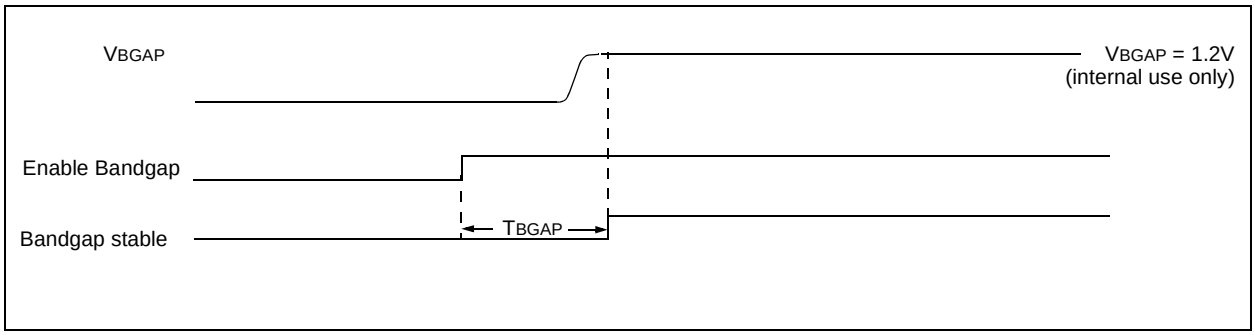


TABLE 15-7: BANDGAP START-UP TIME

Param. No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
36*	TBGAP	Bandgap start-up time	—	19	33	μS	Defined as the time between the instant that the bandgap is enabled and the moment that the bandgap reference voltage is stable.

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

15.4.3 PROGRAMMABLE BROWN-OUT RESET MODULE (PBOR)

TABLE 15-9: DC CHARACTERISTICS: PBOR

DC CHARACTERISTICS			Standard Operating Conditions (unless otherwise stated) Operating temperature 0°C ≤ TA ≤ +70°C for commercial -40°C ≤ TA ≤ +85°C for industrial -40°C ≤ TA ≤ +125°C for extended Operating voltage VDD range as described in DC Characteristics Section 15.1.					
Param. No.	**Characteristic**		**Symbol**	**Min**	**Typ**	**Max**	**Units**	**Conditions**
D005	BOR Voltage	BORV<1:0> = 11	VBOR	2.5	2.58	2.66	V	
		BORV<1:0> = 10		2.7	2.78	2.86		
		BORV<1:0> = 01		4.2	4.33	4.46		
		BORV<1:0> = 00		4.5	4.64	4.78		

15.4.4 VREF MODULE

TABLE 15-10: DC CHARACTERISTICS: VREF

DC CHARACTERISTICS			Standard Operating Conditions (unless otherwise stated) Operating temperature 0°C ≤ TA ≤ +70°C for commercial -40°C ≤ TA ≤ +85°C for industrial -40°C ≤ TA ≤ +125°C for extended Operating voltage VDD range as described in DC Characteristics Section 15.1.					
Param. No.	**Symbol**	**Characteristic**	**Min**	**Typ†**	**Max**	**Units**	**Conditions**	
D400	VRL	Output Voltage	2.0	2.048	2.1	V	VDD ≥ 2.7V, -40°C ≤ TA ≤ +85°C	
	VRH		4.0	4.096	4.2	V	VDD ≥ 4.5V, -40°C ≤ TA ≤ +85°C	
D400A	VRL	Output Voltage	1.9	2.048	2.2	V	VDD ≥ 2.7V, -40°C ≤ TA ≤ +125°C	
	VRH		4.0	4.096	4.3	V	VDD ≥ 4.5V, -40°C ≤ TA ≤ +125°C	
D404*	IVREFSO	External Load Source	—	—	5	mA		
D405*	IVREFSI	External Load Sink	—	—	-5	mA		
*	CL	External Capacitor Load	—	—	200	pF		
D406*	ΔVout/ ΔIout	VRH Load Regulation	—	0.6	1	mV/mA	VDD ≥ 5V	ISOURCE = 0 mA to 5 mA
			—	1	4			ISINK = 0 mA to 5 mA
		VRL Load Regulation	—	0.6	1		VDD ≥ 3V	ISOURCE = 0 mA to 5 mA
			—	2	4			ISINK = 0 mA to 5 mA

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

TABLE 15-22: MASTER SSP I^2C BUS DATA REQUIREMENTS

Param. No.	Symbol	Characteristic		Min	Max	Units	Conditions
100*	THIGH	Clock high time	100 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			400 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—	ms	
101*	TLOW	Clock low time	100 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			400 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—	ms	
102*	TR	SDA and SCL rise time	100 kHz mode	—	1000	ns	Cb is specified to be from 10 to 400 pF
			400 kHz mode	20 + 0.1Cb	300	ns	
			1 MHz mode(1)	—	300	ns	
103*	TF	SDA and SCL fall time	100 kHz mode	—	300	ns	Cb is specified to be from 10 to 400 pF
			400 kHz mode	20 + 0.1Cb	300	ns	
			1 MHz mode(1)	—	100	ns	
90*	TSU:STA	START condition setup time	100 kHz mode	2(TOSC)(BRG + 1)	—	ms	Only relevant for Repeated START condition
			400 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—	ms	
91*	THD:STA	START condition hold time	100 kHz mode	2(TOSC)(BRG + 1)	—	ms	After this period the first clock pulse is generated
			400 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—	ms	
106*	THD:DAT	Data input hold time	100 kHz mode	0	—	ns	
			400 kHz mode	0	0.9	ms	
			1 MHz mode(1)	TBD	—	ns	
107*	TSU:DAT	Data input setup time	100 kHz mode	250	—	ns	**Note 2**
			400 kHz mode	100	—	ns	
			1 MHz mode(1)	TBD	—	ns	
92*	TSU:STO	STOP condition setup time	100 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			400 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—	ms	
109*	TAA	Output valid from clock	100 kHz mode	—	3500	ns	
			400 kHz mode	—	1000	ns	
			1 MHz mode(1)	—	—	ns	
110	TBUF	Bus free time	100 kHz mode	4.7 ‡	—	ms	Time the bus must be free before a new transmission can start
			400 kHz mode	1.3 ‡	—	ms	
			1 MHz mode(1)	TBD‡	—	ms	
D102 ‡	Cb	Bus capacitive loading		—	400	pF	

* These parameters are characterized but not tested. For the value required by the I^2C specification, please refer to the PICmicro™ Mid-Range MCU Family Reference Manual (DS33023).

‡ These parameters are for design guidance only and are not tested, nor characterized.

Note 1: Maximum pin capacitance = 10 pF for all I^2C pins.

2: A Fast mode I^2C bus device can be used in a Standard mode I^2C bus system, but (TSU:DAT) ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line.
[(TR) + (TSU:DAT) = 1000 + 250 = 1250 ns], for 100 kHz mode, before the SCL line is released.

FIGURE 16-20: TYPICAL AND MAXIMUM ΔITMR1 VS. VDD (32 KHZ, -40°C TO +125°C)

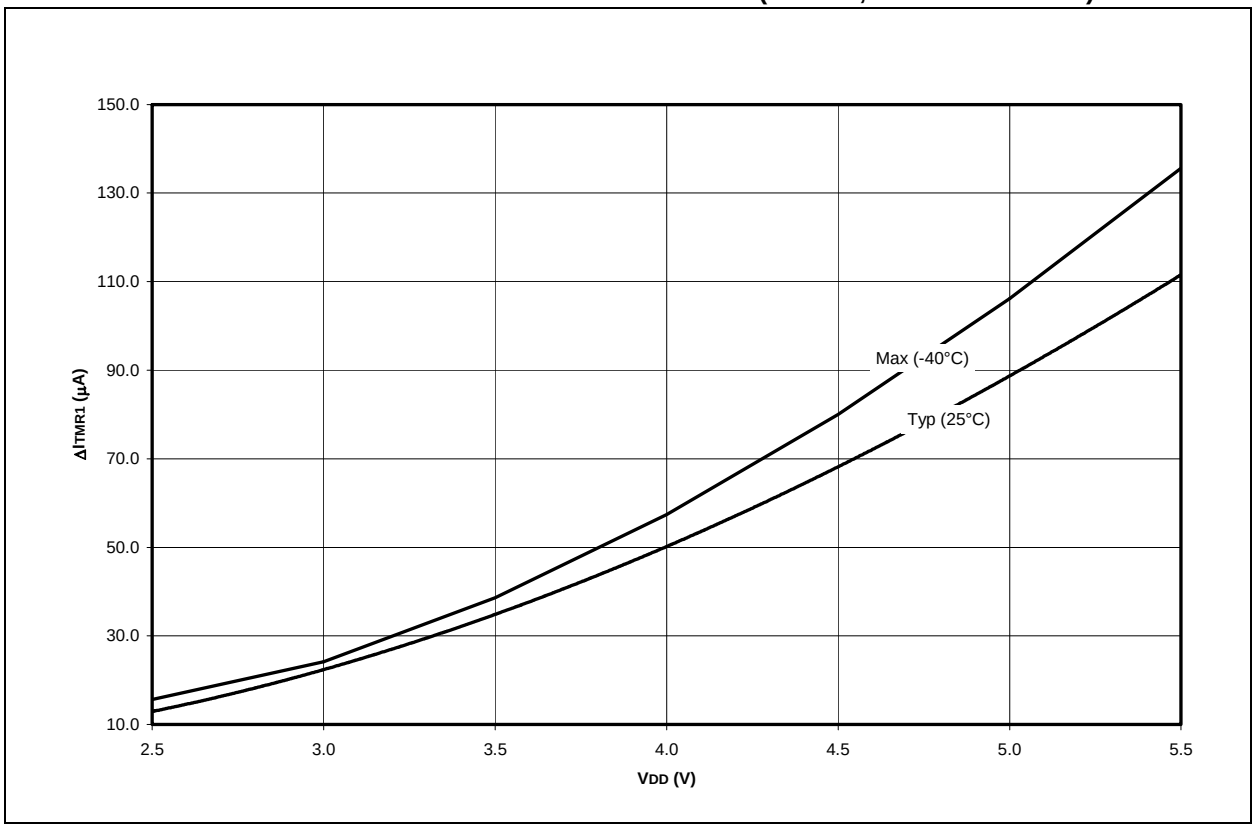
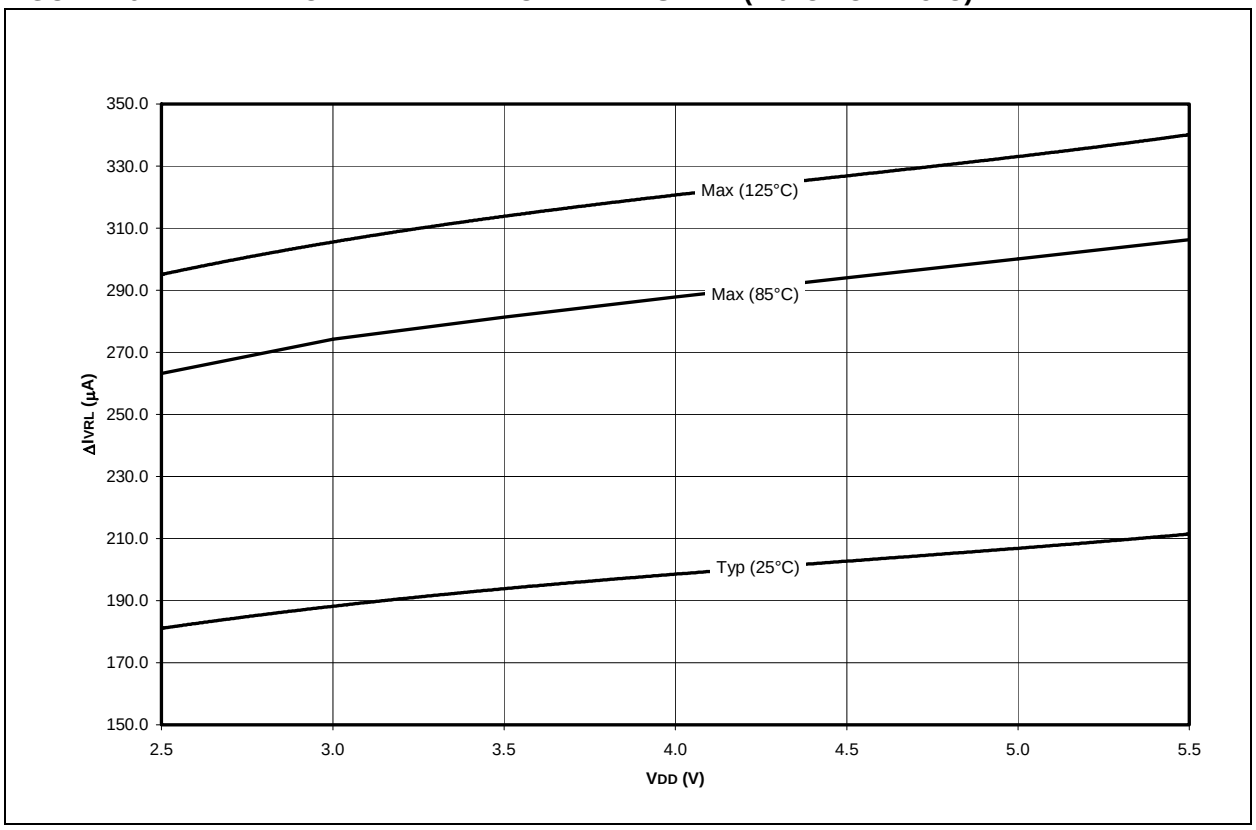


FIGURE 16-21: TYPICAL AND MAXIMUM ΔIVRL VS. VDD (-40°C TO +125°C)



17.6 20-Lead Ceramic Dual In-line with Window (JW) – 300 mil (CERDIP)

DRAWING NOT AVAILABLE